

Dual N-Channel 20-V (D-S) MOSFET

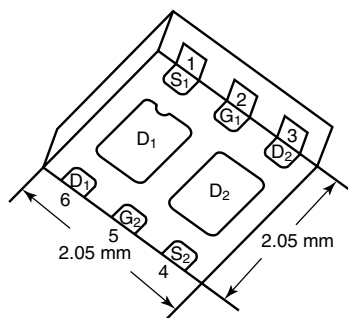
PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
20	0.053 at V _{GS} = 4.5 V	4.5	4.1 nC
	0.063 at V _{GS} = 2.5 V	4.5	
	0.077 at V _{GS} = 1.8 V	4.5	

FEATURES

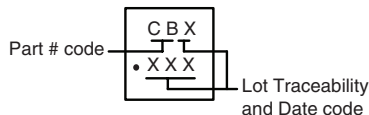
- Halogen-free
- TrenchFET[®] Power MOSFET
- New Thermally Enhanced PowerPAK[®] SC-70 Package
 - Small Footprint Area
 - Low On-Resistance


RoHS
COMPLIANT

PowerPAK SC-70-6 Dual

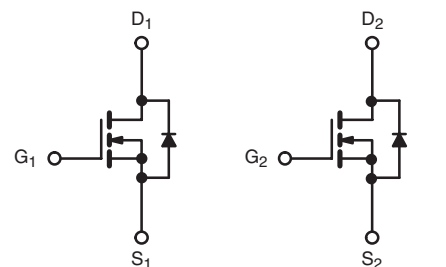


Marking Code



APPLICATIONS

- Load Switch for Portable Applications



N-Channel MOSFET

N-Channel MOSFET

Ordering Information: SiA914DJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted				
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	20	V	
Gate-Source Voltage	V _{GS}	± 8		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	4.5 ^a	A	
	T _C = 70 °C	4.5 ^a		
	T _A = 25 °C	4.5 ^{a, b, c}		
	T _A = 70 °C	3.8 ^{b, c}		
Pulsed Drain Current	I _{DM}	20	A	
Continuous Source-Drain Diode Current	T _C = 25 °C	4.5 ^a		
	T _A = 25 °C	1.6 ^{b, c}		
Maximum Power Dissipation	T _C = 25 °C	6.5	W	
	T _C = 70 °C	5		
	T _A = 25 °C	1.9 ^{b, c}		
	T _A = 70 °C	1.2 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}		260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	52	65	°C/W
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	12.5	16	

Notes:

a. Package limited

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See Solder Profile (<http://www.vishay.com/ppg73257>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 110 °C/W.

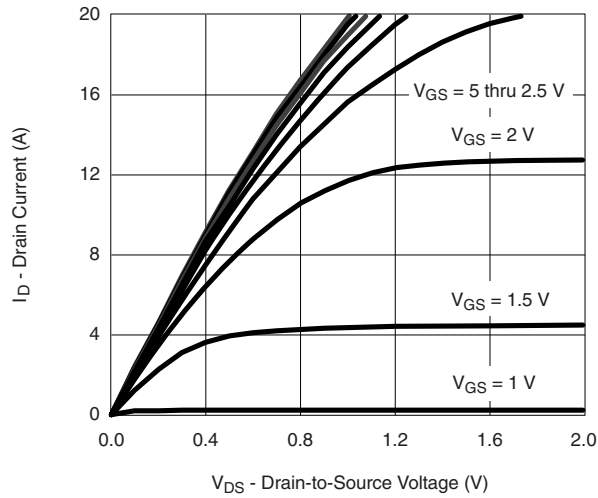
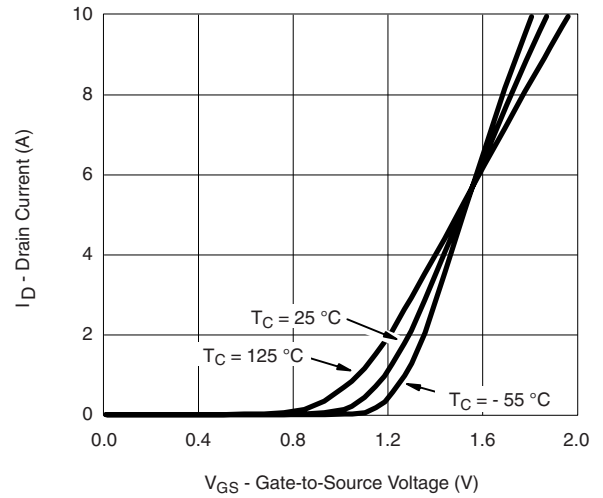
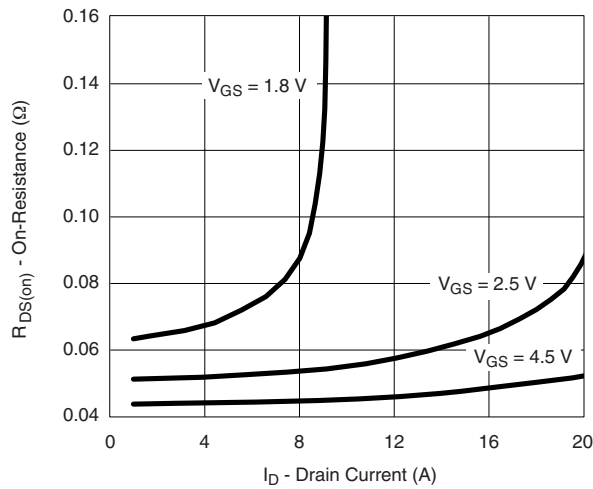
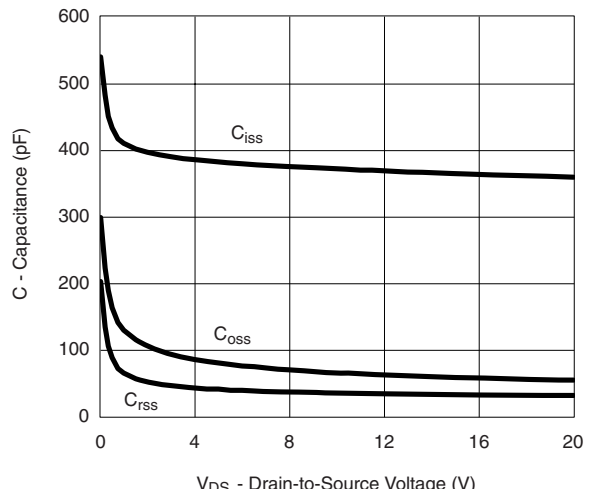
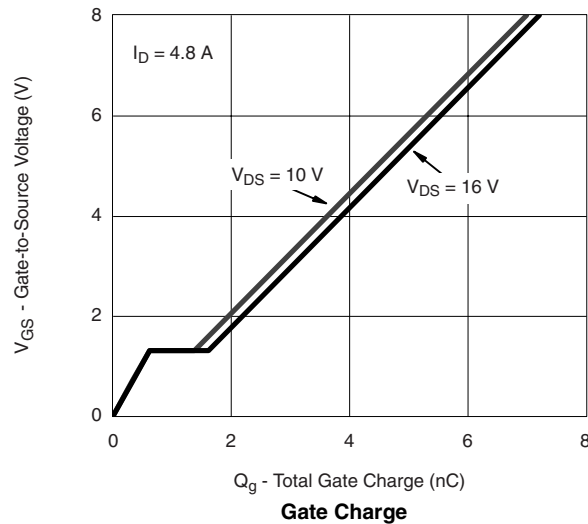
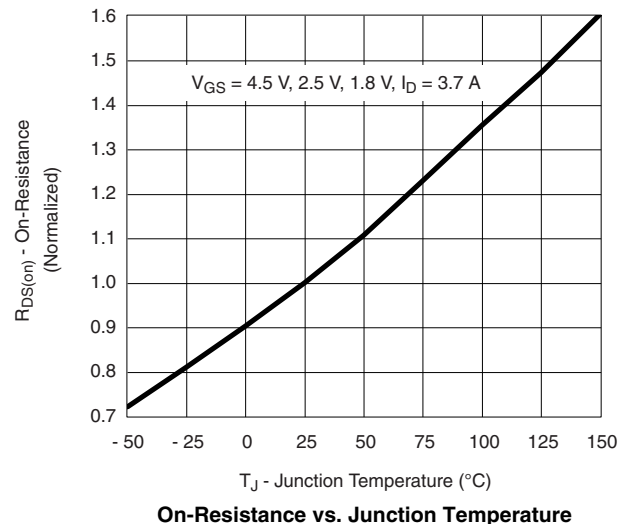
SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	20			V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA		19		mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J			- 2.8		
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.4		1.0	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 8 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			- 1	μA
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C			- 10	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≤ 5 V, V _{GS} = 4.5 V	- 20			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 3.7 A		0.043	0.053	Ω
		V _{GS} = 2.5 V, I _D = 3.4 A		0.052	0.063	
		V _{GS} = 1.8 V, I _D = 1.1 A		0.062	0.077	
Forward Transconductance ^a	g _{fs}	V _{DS} = 10 V, I _D = 3.7 A		15		S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		400		pF
Output Capacitance	C _{oss}			70		
Reverse Transfer Capacitance	C _{rss}			40		
Total Gate Charge	Q _g	V _{DS} = 10 V, V _{GS} = 8 V, I _D = 4.8 A		7	11.5	nC
		V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 4.8 A		4.1	7	
Gate-Source Charge	Q _{gs}			0.65		
Gate-Drain Charge	Q _{gd}			0.8		
Gate Resistance	R _g	f = 1 MHz		2.5		Ω
Turn-on Delay Time	t _{d(on)}	V _{DD} = 10 V, R _L = 2.6 Ω I _D ≅ 3.8 A, V _{GEN} = 4.5 V, R _g = 1 Ω		5	10	ns
Rise Time	t _r			32	50	
Turn-Off Delay Time	t _{d(off)}			30	45	
Fall Time	t _f			53	80	
Turn-on Delay Time	t _{d(on)}	V _{DD} = 10 V, R _L = 2.6 Ω I _D ≅ 3.8 A, V _{GEN} = 8 V, R _g = 1 Ω		5	10	
Rise Time	t _r			12	20	
Turn-Off Delay Time	t _{d(off)}			15	25	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			4.5	A
Pulse Diode Forward Current	I _{SM}				20	
Body Diode Voltage	V _{SD}	I _S = 3.8 A, V _{GS} = 0 V		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = 3.8 A, di/dt = 100 A/μs, T _J = 25 °C		15	30	ns
Body Diode Reverse Recovery Charge	Q _{rr}			8.5	20	nC
Reverse Recovery Fall Time	t _a			10		ns
Reverse Recovery Rise Time	t _b			5		

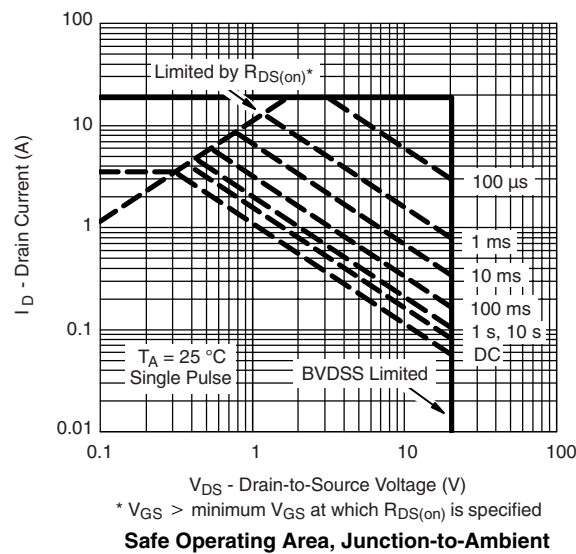
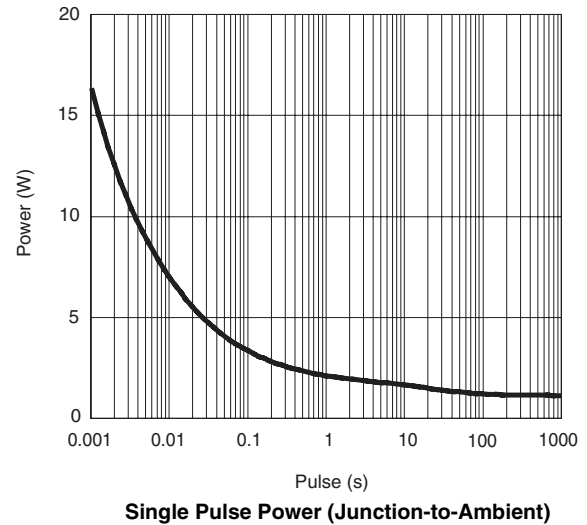
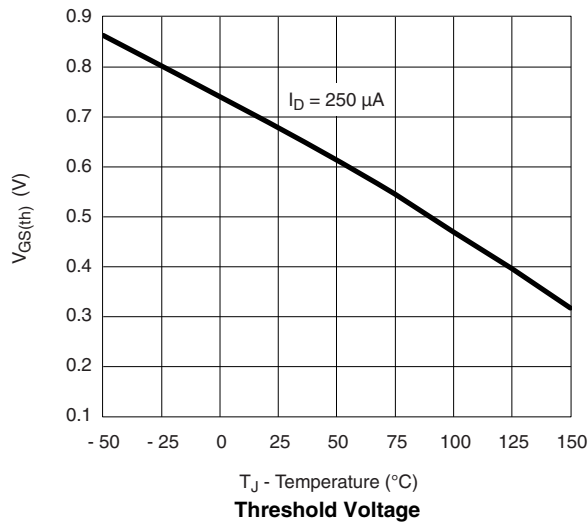
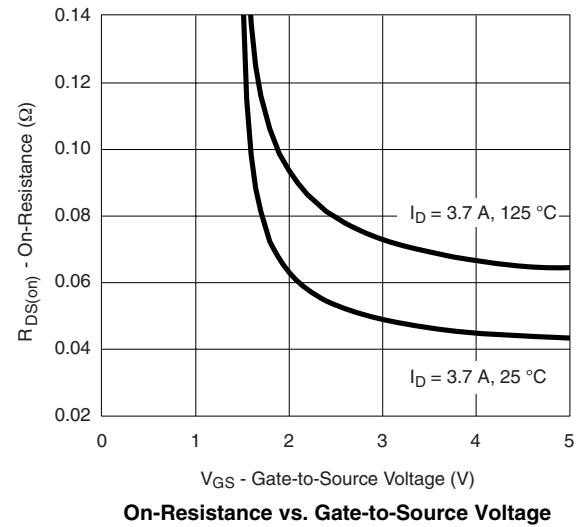
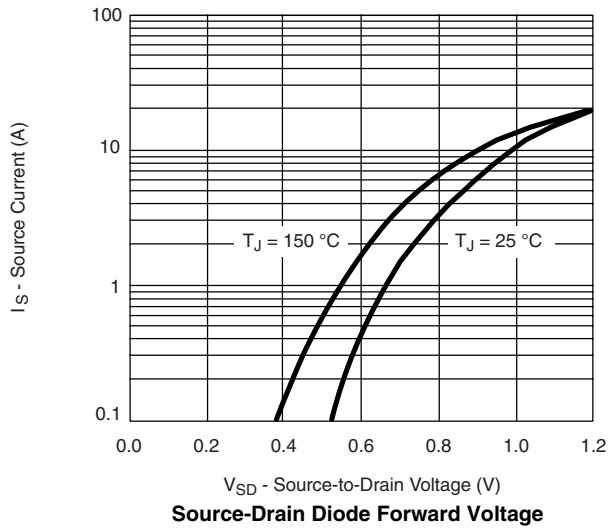
Notes:

a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$

b. Guaranteed by design, not subject to production testing.

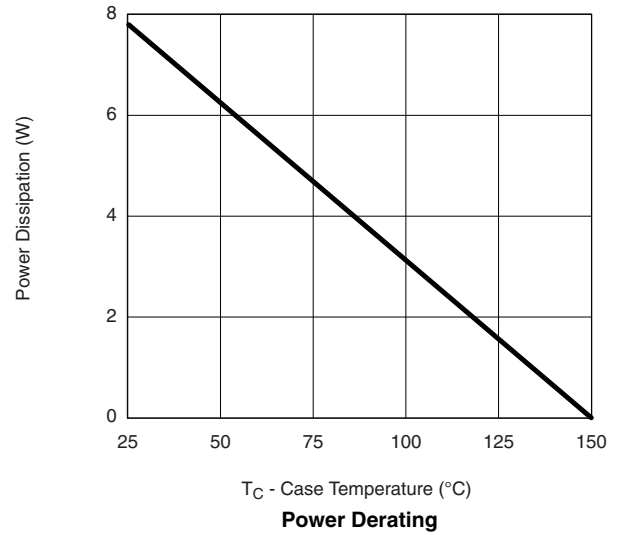
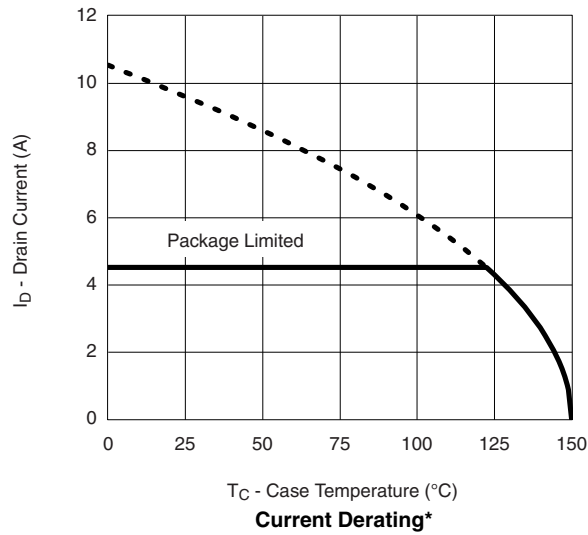
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS** 25 °C, unless otherwise noted**Output Characteristics****Transfer Characteristics****On-Resistance vs. Drain Current and Gate Voltage****Capacitance****Gate Charge****On-Resistance vs. Junction Temperature**

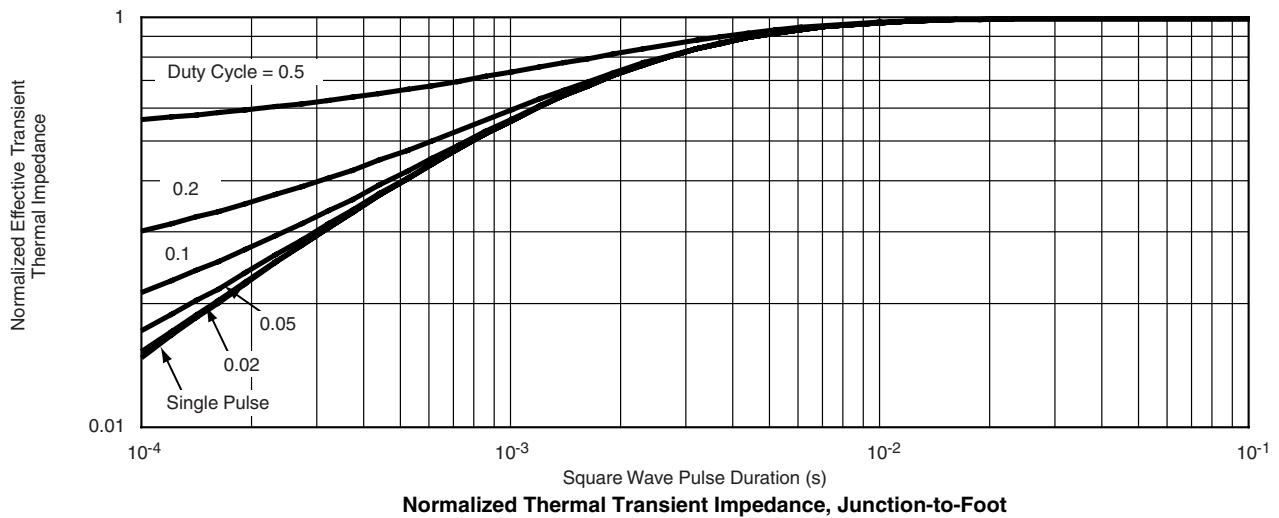
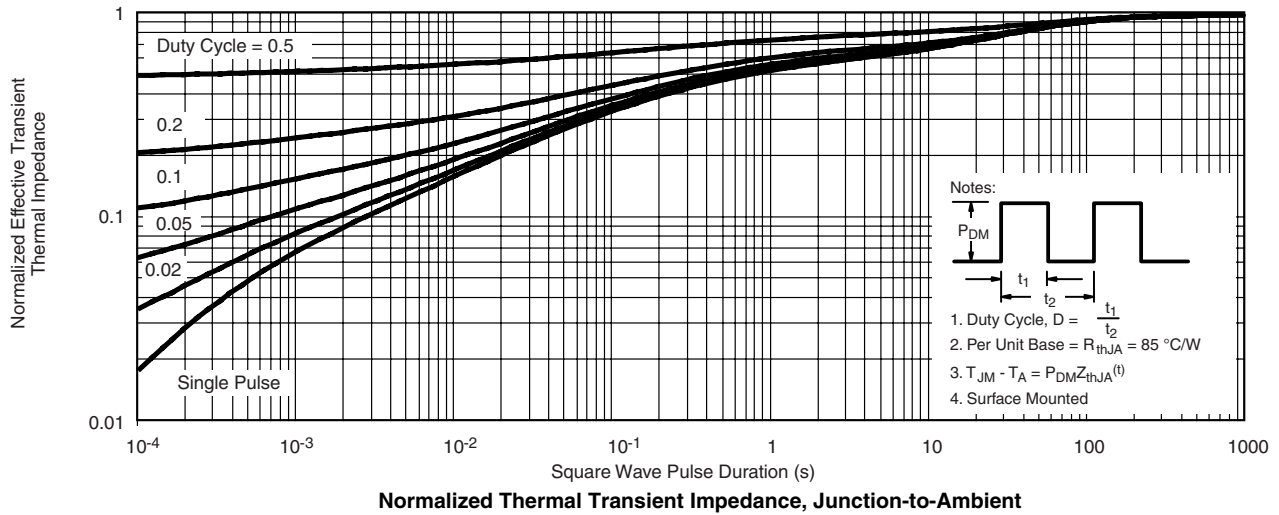
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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